

SPP 25

Polypropylene Texture Powder






Product Description:

The SPP Series consists of polypropylene powders in a controlled range of particle sizes. These products can be easily dispersed under high-speed mixing in solvent, UV, or water-based inks & coatings.




Application:

SPP products are recommended in both air dry and low-temperature baked coatings for solvent, UV, and aqueous systems at 5-10% of total formula weight.

Features and Benefits:

-  Abrasion Resistance
-  Mar/Scuff Resistance
-  Texture
-  Anti-Slip
-  Matting

Typical Properties:

-  Particle Size Mean Value: 25 μm
-  Specific Gravity: 0.93 g/cm³
-  Melting Point: 298°F /148°C

Regulatory Status

The components of this product are listed on multiple chemical inventories. For specific information on the applicable chemical inventories, please refer to the product SDS.

Safety, Shipping and Handling

For complete safety, shipping and handling information, please refer to the product SDS, contact your regional Customer Service Representative, or contact our Customer Service Team by e-mail at customerserviceteam@shamrocktechnologies.com.

For more information about Shamrock's other products, please visit us at our website, ShamrockTechnologies.com.

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